

Title (en)

Method for setting a metallic wire or tape on a thin sheet and roll of this sheet

Title (de)

Verfahren zum Anbringen eines metallischen Drahtes oder Bandes auf einem dünnen Blatt und Rolle von diesem Blatt

Title (fr)

Procédé de mise en place d'au moins un fil ou une bande métallique sur une feuille mince et bobine de cette feuille

Publication

**EP 0798682 B1 19991110 (FR)**

Application

**EP 97400440 A 19970227**

Priority

FR 9603949 A 19960329

Abstract (en)

[origin: EP0798682A1] The process applies threads or strips (3a-3d) of high-permeability magnetic material to the sheet (2) of plastic, paper or aluminium which can be assembled to another sheet (1) with the metal sandwiched between the two. The threads or strips are arranged in wavy lines (S) along the length of the sheet so that when the latter is coiled, sections of metal situated in adjacent turns of the coil and in the same plane through its axis are laterally offset.

IPC 1-7

**G08B 13/24**

IPC 8 full level

**B65H 18/10** (2006.01); **B29D 7/00** (2006.01); **B65H 18/28** (2006.01); **B65H 49/00** (2006.01); **G08B 13/24** (2006.01)

CPC (source: EP KR US)

**G08B 13/2408** (2013.01 - EP US); **G08B 13/2437** (2013.01 - EP US); **G08B 13/244** (2013.01 - EP US); **G08B 13/2445** (2013.01 - EP US); **H01F 41/14** (2013.01 - KR); **Y10S 428/90** (2013.01 - EP US); **Y10T 428/1234** (2015.01 - EP US); **Y10T 428/12444** (2015.01 - EP US); **Y10T 428/12465** (2015.01 - EP US); **Y10T 428/12736** (2015.01 - EP US); **Y10T 428/2922** (2015.01 - EP US)

Cited by

FR2780030A1

Designated contracting state (EPC)

AT BE CH DE DK ES FI FR GB GR IE IT LI LU NL PT SE

DOCDB simple family (publication)

**EP 0798682 A1 19971001; EP 0798682 B1 19991110**; AT E186605 T1 19991115; CA 2196588 A1 19970930; CA 2196588 C 20030114; DE 69700761 D1 19991216; DE 69700761 T2 20000621; DK 0798682 T3 20000515; ES 2141583 T3 20000316; FR 2746956 A1 19971003; FR 2746956 B1 19980507; GR 3032169 T3 20000427; IL 120195 A0 19970610; IL 120195 A 20000601; JP 2820678 B2 19981105; JP H10181957 A 19980707; KR 100244070 B1 20000201; KR 970067416 A 19971013; NO 322787 B1 20061211; NO 971374 D0 19970324; NO 971374 L 19970930; US 6020074 A 20000201; ZA 971540 B 19970829

DOCDB simple family (application)

**EP 97400440 A 19970227**; AT 97400440 T 19970227; CA 2196588 A 19970131; DE 69700761 T 19970227; DK 97400440 T 19970227; ES 97400440 T 19970227; FR 9603949 A 19960329; GR 990403254 T 19991217; IL 1201957 A 19970210; JP 9666097 A 19970331; KR 19970009874 A 19970321; NO 971374 A 19970324; US 82954897 A 19970328; ZA 971540 A 19970221